

Attorney Docket No.: AAT007 US

DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below adjacent to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled

MODULAR BIPOLAR-CMOS-DMOS ANALOG INTEGRATED CIRCUIT

AND POWER TRANSISTOR TECHNOLOGY

which was filed on September 30, 2002, 2002, as U.S. Application No. 10/262,567.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application(s) and the national or PCT internatational filing date of this application:

Application Serial No.	Filing Date	Status (patented, pending, abandoned)
N/A		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

David E. Steuber (25,557); Michael J. Halbert (40,633); Omkar K. Suryadevara (36,320)

Please address all correspondence and telephone calls to:

David E. Steuber
Attorney for Applicant(s)
Silicon Valley Patent Group LLP
2350 Mission College Boulevard
Suite 360
Santa Clara, California 95054

Telephone: 408-982-8200 Fax: 408-982-8210 Telephone: 408-982-8200 Fax: 408-982-8210

I acknowledge that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of sole (or first joint) inventor: Richard K. Williams					
Inventor's signature:	Quel & Will	Date: 11/22/02			
Residence: Cupertino, Ca	slifornia	, ,			
Post Office Address:	10292 Norwich Ave. Citizenship: Cupertino, California 95014	US			
Full name of second joint inventor: Michael E. Cornell					
Inventor's signature:		Date:			
Residence: Campbell, Ca	lifornia				
Post Office Address:	1576 Summerfield Drive Citizenship: Campbell, California 95008	US			
Full name of third joint inventor: Wai Tien Chan					
Inventor's signature:		Date:			
Residence: Hong Kong					
Post Office Address:	Flat F, 23/F Citizenship: China Block 5 Regentville, Fanling, N.T. Hong Kong				

I acknowledge that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of sole (or first	joint) inventor:R	Richard K. Williams		
Inventor's signature:			Date:	
Residence: Cupertino, Ca	llifornia			
Post Office Address:	10292 Norwich Ave. Cupertino, California 950		: <u>US</u>	
-	inventor:	_		
Inventor's signature:	Michael Car	ull/	Date: December	21 18,2002
Residence: Campbell, Ca	llifornia	,		
Post Office Address:	1576 Summerfield Drive Campbell, California 95		o: <u>US</u>	
Full name of third joint in	nventor: Wai Tien	Chan	·	
Inventor's signature:			Date:	
Residence: Hong Kong				
Post Office Address:	Flat F, 23/F Block 5 Regent ville, Fanling, N. 7	Citizenship: <u>Singa</u>	pore	

Hong Kong

I acknowledge that all statements made herein of my own knowledge are true, all statements made herein on information and belief are believed to be true, and all statements made herein are made with the knowledge that whoever, in any matter within the jurisdiction of the Patent and Trademark Office, knowingly and willfully falsifies, conceals, or covers up by any trick, scheme, or device a material fact, or makes any false, fictitious or fraudulent statements or representations, or makes or uses any false writing or document knowing the same to contain any false, fictitious or fraudulent statement or entry, shall be subject to the penalties including fine or imprisonment or both as set forth under 18 U.S.C. 1001, and that violations of this paragraph may jeopardize the validity of the application or this document, or the validity or enforceability of any patent, trademark registration, or certificate resulting therefrom.

Full name of sole (or first	joint) inventor: Richard	K. Williams			
Inventor's signature:			Date:		
Residence: Cupertino, Ca	lifornia				
Post Office Address:	10292 Norwich Ave. Cupertino, California 95014	Citizenship:	US		
Full name of second joint	inventor: Michae	el E. Cornell	<u> </u>		
Inventor's signature:		1	Date:		
Residence: Campbell, California					
Post Office Address:	1576 Summerfield Drive Campbell, California 95008	Citizenship:	US		
Full name of third joint inventor: Wai Tien Chan					
Inventor's signature:	The state of the s		Date: 16 Dec, 02		
Residence: Hong Kong					
Post Office Address:	Flat F, 23/F Cities Block 5 Regentville, Fanling, N.T. Hong Kong	zenship: <u>Singap</u>	ore		